

Description

The SJPX-H6 is a fast recovery diode of 600 V / 2.0 A. The maximum t_{rr} of 30 ns is realized by optimizing a life-time control.

Features

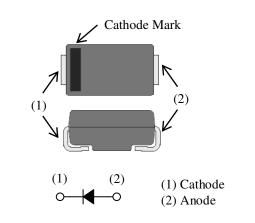
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0
- Suitable for High Reliability and Automotive Requirement.

Applications

• Freewheel Diode (Offline Buck Converter, Offline Buck-boost Converter, etc.)

Package

SJP



Not to scale

Absolute Maximum Ratings

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V _{RSM}		600	V
Repetitive Peak Reverse Voltage	V _{RM}		600	V
Average Forward Current	I _{F(AV)}	See Figure 2 and Figure 3	2.0	А
Surge Forward Current	I _{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	20	А
I ² t Limiting Value	I ² t	$1 \text{ ms} \le t \le 10 \text{ ms}$	2.0	A ² s
Junction Temperature	TJ		-40 to 150	°C
Storage Temperature	T _{STG}		-40 to 150	°C

Unless otherwise specified, $T_A = 25 \ ^{\circ}C$.

Electrical Characteristics

Unless otherwise specified, $T_A = 25 \ ^{\circ}C$.						
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop V _F	V	$T_J = 25 \ ^{\circ}C, I_F = 2.0 \text{ A}$			1.5	V
	V _F	$T_J = 100 \ ^{\circ}C, I_F = 2.0 \text{ A}$	_	1.1		V
Reverse Leakage Current	I _R	$V_R = V_{RM}$	_	_	10	μA
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 \ ^\circ C$			3.0	mA
Reverse Recovery Time	t _{rr1}	$I_F = I_{RP} = 100 \text{ mA},$ 90% recovery point, $T_J = 25 \text{ °C}$			30	ns
	t _{rr2}	$I_{F} = 100 \text{ mA}, I_{RP} = 200 \text{ mA},$ 75% recovery point, $T_{J} = 25 \text{ °C}$	_		20	ns
Thermal Resistance ⁽¹⁾	R _{th(J-L)}			_	20	°C/W

Mechanical Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Package Weight			0.072		g

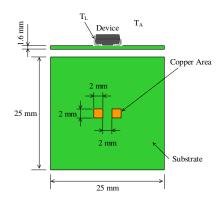


Figure 1. Lead Temperature Measurement Conditions

 $^{^{(1)}}$ R_{th (J-L)} is thermal resistance between junction and lead. Lead temperature (T_L) is measured near the root of pin (see Figure 1).

SJPX-H6

Derating Curves

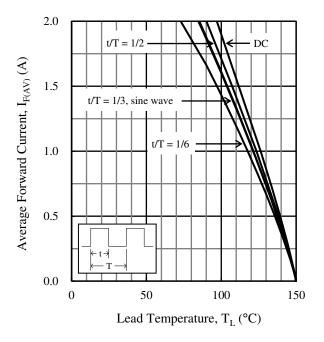


Figure 2. $I_{F(AV)}$ vs. T_L ($T_J = 150 \text{ °C}$, $V_R = 0 \text{ V}$)

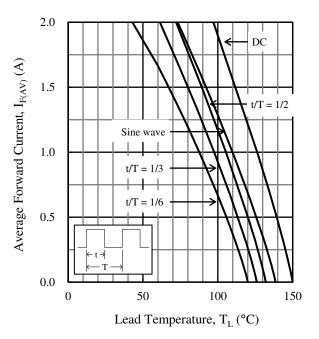


Figure 3. $I_{F(AV)}$ vs. $T_L (T_J = 150 \text{ °C}, V_R = 600 \text{ V})$

Characteristic Curves

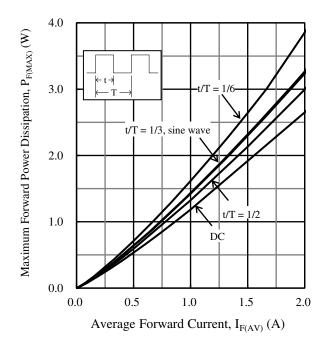


Figure 4. $P_{F(MAX)}$ vs. $I_{F(AV)}$ (T_J = 150 °C)

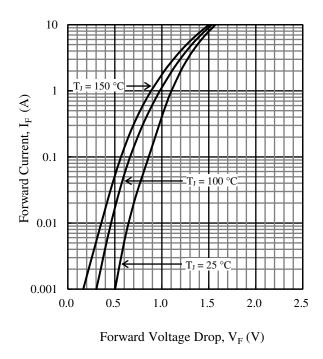


Figure 6. Typical Characteristics: IF vs. VF

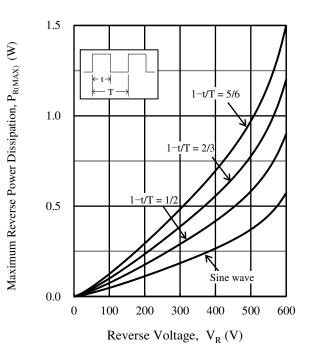


Figure 5. $P_{R(MAX)}$ vs. V_R ($T_J = 150 \ ^{\circ}C$)

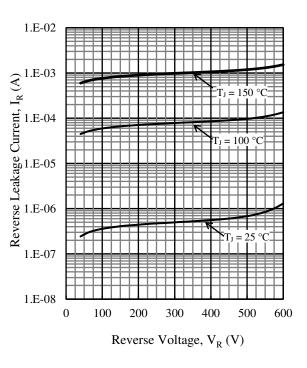


Figure 7. Typical Characteristics: I_R vs. V_R

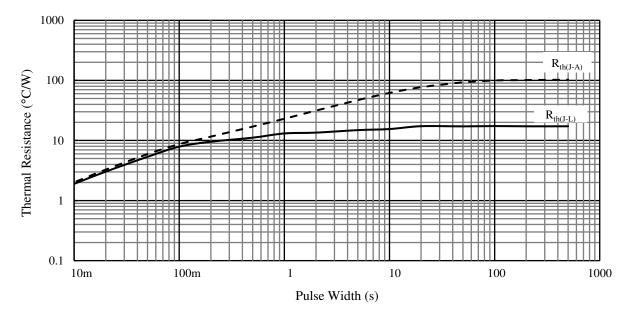
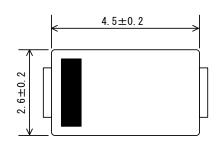
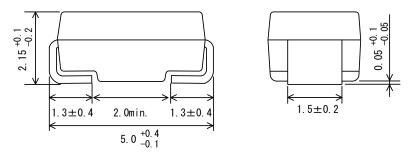


Figure 8. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

• SJP Package





NOTES:

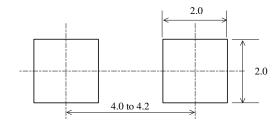
- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- Moisture Sensitivity Level 1 (MSL 1)
- When soldering the products, it is required to minimize the working time within the following limits:
- Flow: 260 °C / 10 s, 1 time Reflow:

Preheat: 150 °C to 200 °C / 60 s to 120 s

Solder heating: 255 °C / 30s, 3 times (260 °C peak)

- Soldering Iron: 350 °C / 3.5 s, 1 time

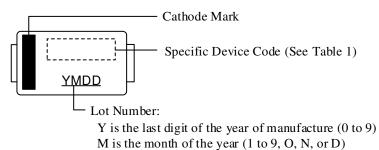
• SJP Land Pattern Example



NOTE:

- Dimensions in millimeters

Marking Diagram



DD is the day of the month (01 to 31)

Table 1. Specific Device Code

Specific Device Code	Part Number
XH6	SJPX-H6

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